OV20880-4C 20MP product brief





a lead-free

package

20-Megapixel Second-Generation 1.0-Micron PureCel®Plus-S Sensor for Front-Facing Cameras

OmniVision's OV20880-4C is an ultra-compact image sensor engineered to bring 20-megapixel resolution to produce "super selfies" for high-end mobile applications using OmniVision's second-generation, 1.0-micron PureCel*Plus-S pixel technology. The OV20880-4C's onchip pixel binning feature allows four times more light photons than a regular 1.0-micron pixel, enabling highsensitivity and clear images in all lighting environments. The OV20880-4C pairs with OmniVision's complete software solution for resolution recovery and highresolution, 20-megapixel selfies combined with a 4-cell mode. The OV20880-4C offers a full 20-megapixel 4-cell RAW output mode and a 5-megapixel Bayer output mode that uses in-pixel binning to achieve 2.0-micron pixel performance. The OV20880-4C captures full-resolution 20-megapixel images and video at 30 frames per second (fps) and 1080p full high definition (HD) video at 120 fps. The OV20880-4C offers both MIPI D-PHY and C-PHY interfaces.

The OV20880-4C can fit in a package size of 8.5 x 8.5 mm with a z-height of 5.0 mm.

Find out more at www.ovt.com.





Applications

- Smartphones
- Video Conferencing

PC Multimedia

Product Features

- automatic black level calibration (ABLC) two on-chip phase lock loops (PLLs)
- programmable controls for: frame rate - mirror and flip - cropping - windowing
- support for dynamic DPC
- supports output formats: 10-bit RAW RGB DPCM 10-8 compression
- supports horizontal and vertical subsampling
- 20-megapixel resolution, 5184 x 3888, 4-cell color filter, 30 fps
- 5-megapixel resolution, 2592 x 1944, output Bayer pattern after quadra binned, 120 fps

- standard serial SCCB interface with speed up to 1 MHz
- programmable I/O drive capability
- embedded 20 kbits of one-time programmable (OTP) memory with 12 kbits reserved for customer use
- and EIS support
- long exposure time of up to 30 seconds

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OV20880-GA5A-4C (color, chip probing, 150 µm backgrinding, reconstructed wafer with good die)

Product Specifications

- active array size: 5184 x 3888
- power supply:
 core: 1.05V analog: 2.8V
- 1/0: 1.8V
- power requirements: active: 349 mW - standby: 10 mW
- XSHUTDOWN: 5 µA
- temperature range: - operating: -30°C to +85°C junction temperature - stable image: 0°C to +60°C junction
- temperature
- output formats: 10-bit RGB RAW, DPCM 10-8 compression
- lens chief ray angle: 34.86° non-linear
- lens size: 1/2.76"
- input clock frequency: 6 64 MHz

- maximum image transfer rate: 5184 x 3888: 30 fps - 2592 x 1944: 120 fps - 1920 x 1080: 180 fps - 1280 x 720: 180 fps
- sensitivity: 14,200 e⁻/Lux-sec @ 530 nm in 4C bin mode
- max S/N ratio: 37.8 dB
- dynamic range: 64.8 dB @ 1x gain
- scan mode: progressive
- **pixel size:** 1.0 μm x 1.0 μm
- dark current: 4 e⁻/sec @ 60°C junction temperature
- image area: 5257.73 µm x 3951.36 µm
- die dimensions: COB: 6210 µm x 4446 µm - RW: 6260 µm x 4516 µm

Functional Block Diagram





- (when clock input is >10 MHz)
- up to 4-lane MIPI TX interface with speed up to 1.92 Gbps/lane
- - gyro interface with 4-wire SPI

 - built-in temperature sensor
 - typical module size: 8.5 x 8.5 x 5.3 mm